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Atty. Docket No. CPAC 1017-2  
Appl. No. 10/632,549

NOV 29 2005

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Applicant:** Marcos KARNEZOS

Application No.: 10/632,549

Filed: August 2, 2003

**Title: Semiconductor multi-package module having wire bond interconnect between stacked packages**

Examiner: Phat X. CAO

Group Art Unit: 2814

Date: 29 November, 2005.

**CERTIFICATE OF FACSIMILE TRANSMISSION**

I hereby certify that this correspondence is being facsimile transmitted to Mail Stop RCE in the United States Patent and Trademark Office, at the Central Fax no. 571-273-8300 on 29 November 2005.

**Signed**

**Bill Kennedy**

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AMENDMENT  
ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION

Dear Sir:

**Applicant responds as follows to the Final Office action mailed June 29, 2005.**

**Amendments to the Specification begin on page 2 of this paper.**

Amendments to the claims are reflected in the **Listing of Claims** which begins on page 3 of this paper.

**Remarks begin on page 6 of this paper.**